R20TS0615EJ0100

Rev.1.00

Oct. 01, 2020

[Upgrade to revision] Solution Toolkit QE for BLE[RA] V1.1.0:

Development Assistance Tool for Bluetooth® Low Energy

Outline

We have updated the products in the title as follows:

• QE for BLE[RA], the development assistance tool for Bluetooth[®] low energy: From V1.0.0 to V1.1.0 This product is available free of charge.

- 1. Version to Be Updated
 - QE for BLE[RA] V1.0.0

How to check the version: In e² studio, select [Help] and then [e² studio Installation Details], open the [Installed Software] tab,

and then check the version of Renesas QE for $\ensuremath{\mathsf{BLE}}[\ensuremath{\mathsf{RA}}].$

2. Description of Revision

The major revision points are as follows: For details and how to install the product, see the following release note.

QE for BLE[RA] V1.1.0 Release Note https://www.renesas.com/search/keyword-search.html#genre=document&g=r20ut4847

2.1 Improvements to Functionality

Integrated development environment e² studio 64-bit version is now supported.
From this version, the product can be used in the e² studio 64-bit version (e² studio 2020-07 or later) environment. Note that e² studio 32-bit version is no longer supported. Install the QE for BLE[RA] V1.1.0 or later in an environment in which the e² studio 2020-07 or later is installed.

3. Operating Environment

> Integrated development environment e² studio 2020-07 or later

Note that installing the Flexible Software Package (FSP) V1.3.0 or later is required.

You can download the installer that allows you to easily install the e² studio and FSP from the following URL:

https://info.renesas.com/en-fsp-download

For details about how to use this product, see the QE item from the [Help] menu of e^2 studio.



4. Obtaining the Product

Download the installer for QE for BLE[RA] V1.1.0 from the following URL:

https://www.renesas.com/qe-ble



Revision History

		Description	
Rev.	Date	Page	Summary
1.00	Oct.01.20	-	First edition issued

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Contact information

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